

## Presetable Counters

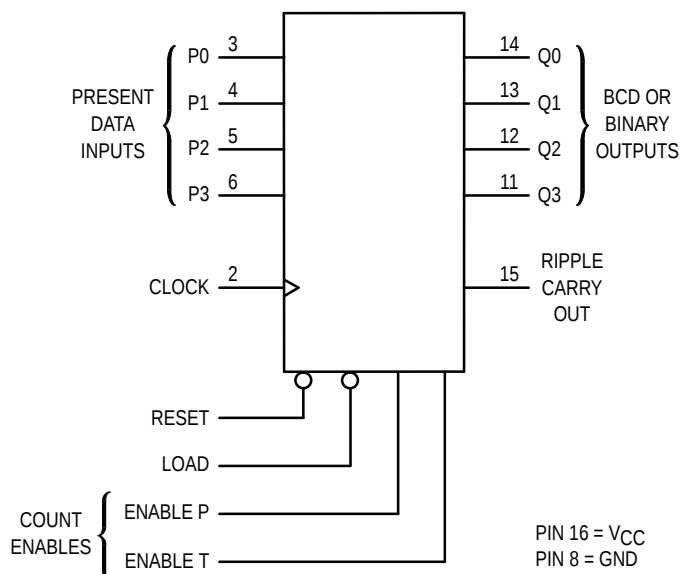
### High-Performance Silicon-Gate CMOS

The MC54/74HC160 and HC162 are identical in pinout to the LS160 and LS162, respectively. The device inputs are compatible with standard CMOS outputs; with pullup resistors, they are compatible with LSTTL outputs.

The HC160 and HC162 are programmable BCD counters with asynchronous and synchronous Reset inputs, respectively.

- Output Drive Capability: 10 LSTTL Loads
- Outputs Directly Interface to CMOS, NMOS, and TTL
- Operating Voltage Range: 2 to 6 V
- Low Input Current: 1  $\mu$ A
- High Noise Immunity Characteristic of CMOS Devices
- In Compliance with the Requirements Defined by JEDEC Standard No. 7A
- Chip Complexity: 234 FETs or 58.5 Equivalent Gates

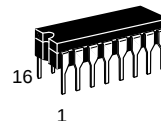
#### LOGIC DIAGRAM



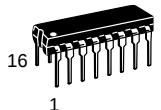
| Device | Count Mode | Reset Mode   |
|--------|------------|--------------|
| HC160  | BCD        | Asynchronous |
| HC162  | BCD        | Synchronous  |

## MC54/74HC160

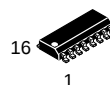
## MC54/74HC162



**J SUFFIX**  
CERAMIC PACKAGE  
CASE 620-10



**N SUFFIX**  
PLASTIC PACKAGE  
CASE 648-08



**D SUFFIX**  
SOIC PACKAGE  
CASE 751B-05

#### ORDERING INFORMATION

|            |         |
|------------|---------|
| MC54HCXXXJ | Ceramic |
| MC74HCXXXN | Plastic |
| MC74HCXXXD | SOIC    |

#### PIN ASSIGNMENT

|          |   |    |                  |
|----------|---|----|------------------|
| RESET    | 1 | 16 | $V_{CC}$         |
| CLOCK    | 2 | 15 | RIPPLE CARRY OUT |
| P0       | 3 | 14 | Q0               |
| P1       | 4 | 13 | Q1               |
| P2       | 5 | 12 | Q2               |
| P3       | 6 | 11 | Q3               |
| ENABLE P | 7 | 10 | ENABLE T         |
| GND      | 8 | 9  | LOAD             |

#### FUNCTION TABLE

| Inputs |        |      |          |          | Output Q         |
|--------|--------|------|----------|----------|------------------|
| Clock  | Reset* | Load | Enable P | Enable T |                  |
|        | L      | X    | X        | X        | Reset            |
|        | H      | L    | X        | X        | Load Preset Data |
|        | H      | H    | H        | H        | Count            |
|        | H      | H    | L        | X        | No Count         |
|        | H      | H    | X        | L        | No Count         |

\* HC162 only. HC160 is an Asynchronous Reset Device

H = high level

L = low level

X = don't care



## MAXIMUM RATINGS\*

| Symbol    | Parameter                                                                                         | Value                   | Unit |
|-----------|---------------------------------------------------------------------------------------------------|-------------------------|------|
| $V_{CC}$  | DC Supply Voltage (Referenced to GND)                                                             | – 0.5 to + 7.0          | V    |
| $V_{in}$  | DC Input Voltage (Referenced to GND)                                                              | – 1.5 to $V_{CC} + 1.5$ | V    |
| $V_{out}$ | DC Output Voltage (Referenced to GND)                                                             | – 0.5 to $V_{CC} + 0.5$ | V    |
| $I_{in}$  | DC Input Current, per Pin                                                                         | $\pm 20$                | mA   |
| $I_{out}$ | DC Output Current, per Pin                                                                        | $\pm 25$                | mA   |
| $I_{CC}$  | DC Supply Current, $V_{CC}$ and GND Pins                                                          | $\pm 50$                | mA   |
| $P_D$     | Power Dissipation in Still Air, Plastic or Ceramic DIP†<br>SOIC Package†                          | 750<br>500              | mW   |
| $T_{stg}$ | Storage Temperature                                                                               | – 65 to + 150           | °C   |
| $T_L$     | Lead Temperature, 1 mm from Case for 10 Seconds<br>(Plastic DIP or SOIC Package)<br>(Ceramic DIP) | 260<br>300              | °C   |

This device contains protection circuitry to guard against damage due to high static voltages or electric fields. However, precautions must be taken to avoid applications of any voltage higher than maximum rated voltages to this high-impedance circuit. For proper operation,  $V_{in}$  and  $V_{out}$  should be constrained to the range  $GND \leq (V_{in} \text{ or } V_{out}) \leq V_{CC}$ . Unused inputs must always be tied to an appropriate logic voltage level (e.g., either GND or  $V_{CC}$ ). Unused outputs must be left open.

\* Maximum Ratings are those values beyond which damage to the device may occur. Functional operation should be restricted to the Recommended Operating Conditions.

† Derating — Plastic DIP: – 10 mW/°C from 65° to 125°C  
Ceramic DIP: – 10 mW/°C from 100° to 125°C  
SOIC Package: – 7 mW/°C from 65° to 125°C

For high frequency or heavy load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

## RECOMMENDED OPERATING CONDITIONS

| Symbol            | Parameter                                            | Min                                                                              | Max                     | Unit |
|-------------------|------------------------------------------------------|----------------------------------------------------------------------------------|-------------------------|------|
| $V_{CC}$          | DC Supply Voltage (Referenced to GND)                | 2.0                                                                              | 6.0                     | V    |
| $V_{in}, V_{out}$ | DC Input Voltage, Output Voltage (Referenced to GND) | 0                                                                                | $V_{CC}$                | V    |
| $T_A$             | Operating Temperature, All Package Types             | – 55                                                                             | + 125                   | °C   |
| $t_r, t_f$        | Input Rise and Fall Time<br>(Figure 1)               | $V_{CC} = 2.0 \text{ V}$<br>$V_{CC} = 4.5 \text{ V}$<br>$V_{CC} = 6.0 \text{ V}$ | 0<br>1000<br>500<br>400 | ns   |

## DC ELECTRICAL CHARACTERISTICS (Voltages Referenced to GND)

| Symbol   | Parameter                                      | Test Conditions                                                                                         | $V_{CC}$<br>V     | Guaranteed Limit   |                         |                          | Unit          |
|----------|------------------------------------------------|---------------------------------------------------------------------------------------------------------|-------------------|--------------------|-------------------------|--------------------------|---------------|
|          |                                                |                                                                                                         |                   | – 55 to<br>25°C    | $\leq 85^\circ\text{C}$ | $\leq 125^\circ\text{C}$ |               |
| $V_{IH}$ | Minimum High-Level Input Voltage               | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$                 | 2.0<br>4.5<br>6.0 | 1.5<br>3.15<br>4.2 | 1.5<br>3.15<br>4.2      | 1.5<br>3.15<br>4.2       | V             |
| $V_{IL}$ | Maximum Low-Level Input Voltage                | $V_{out} = 0.1 \text{ V or } V_{CC} - 0.1 \text{ V}$<br>$ I_{out}  \leq 20 \mu\text{A}$                 | 2.0<br>4.5<br>6.0 | 0.3<br>0.9<br>1.2  | 0.3<br>0.9<br>1.2       | 0.3<br>0.9<br>1.2        | V             |
| $V_{OH}$ | Minimum High-Level Output Voltage              | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 20 \mu\text{A}$                                 | 2.0<br>4.5<br>6.0 | 1.9<br>4.4<br>5.9  | 1.9<br>4.4<br>5.9       | 1.9<br>4.4<br>5.9        | V             |
|          |                                                | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \leq 4.0 \text{ mA}$<br>$ I_{out}  \leq 5.2 \text{ mA}$ | 4.5<br>6.0        | 3.98<br>5.48       | 3.84<br>5.34            | 3.70<br>5.20             |               |
| $V_{OL}$ | Maximum Low-Level Output Voltage               | $V_{in} = V_{IH} \text{ or } V_{IL}$<br>$ I_{out}  \leq 20 \mu\text{A}$                                 | 2.0<br>4.5<br>6.0 | 0.1<br>0.1<br>0.1  | 0.1<br>0.1<br>0.1       | 0.1<br>0.1<br>0.1        | V             |
|          |                                                | $V_{in} = V_{IH} \text{ or } V_{IL}$ $ I_{out}  \leq 4.0 \text{ mA}$<br>$ I_{out}  \leq 5.2 \text{ mA}$ | 4.5<br>6.0        | 0.26<br>0.26       | 0.33<br>0.33            | 0.40<br>0.40             |               |
| $I_{in}$ | Maximum Input Leakage Current                  | $V_{in} = V_{CC} \text{ or } GND$                                                                       | 6.0               | $\pm 0.1$          | $\pm 1.0$               | $\pm 1.0$                | $\mu\text{A}$ |
| $I_{CC}$ | Maximum Quiescent Supply Current (per Package) | $V_{in} = V_{CC} \text{ or } GND$<br>$I_{out} = 0 \mu\text{A}$                                          | 6.0               | 8                  | 80                      | 160                      | $\mu\text{A}$ |

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

**AC ELECTRICAL CHARACTERISTICS** ( $C_L = 50$  pF, Input  $t_r = t_f = 6$  ns)

| Symbol                                 | Parameter                                                                    | V <sub>CC</sub><br>V | Guaranteed Limit |                 |                 | Unit |
|----------------------------------------|------------------------------------------------------------------------------|----------------------|------------------|-----------------|-----------------|------|
|                                        |                                                                              |                      | - 55 to<br>25°C  | ≤ 85°C          | ≤ 125°C         |      |
| f <sub>max</sub>                       | Maximum Clock Frequency (50% Duty Cycle)*<br>(Figures 1 and 7)               | 2.0<br>4.5<br>6.0    | 6.0<br>30<br>35  | 4.8<br>24<br>28 | 4.0<br>20<br>24 | MHz  |
| t <sub>PLH</sub>                       | Maximum Propagation Delay, Clock to Q<br>(Figures 1 and 7)                   | 2.0<br>4.5<br>6.0    | 170<br>34<br>29  | 215<br>43<br>37 | 255<br>51<br>43 | ns   |
| t <sub>PHL</sub>                       |                                                                              | 2.0<br>4.5<br>6.0    | 205<br>41<br>35  | 255<br>51<br>43 | 310<br>62<br>53 |      |
| t <sub>PHL</sub>                       |                                                                              | 2.0<br>4.5<br>6.0    | 210<br>42<br>36  | 265<br>53<br>45 | 315<br>63<br>54 |      |
| t <sub>PLH</sub>                       | Maximum Propagation Delay, Enable T to Ripple Carry Out<br>(Figures 3 and 7) | 2.0<br>4.5<br>6.0    | 160<br>32<br>27  | 200<br>40<br>34 | 240<br>48<br>41 | ns   |
| t <sub>PHL</sub>                       |                                                                              | 2.0<br>4.5<br>6.0    | 195<br>39<br>33  | 245<br>49<br>42 | 295<br>59<br>50 |      |
| t <sub>PLH</sub>                       |                                                                              | 2.0<br>4.5<br>6.0    | 175<br>35<br>30  | 220<br>44<br>37 | 265<br>53<br>45 |      |
| t <sub>PHL</sub>                       | Maximum Propagation Delay, Clock to Ripple Carry Out<br>(Figures 1 and 7)    | 2.0<br>4.5<br>6.0    | 215<br>43<br>37  | 270<br>54<br>46 | 325<br>65<br>55 | ns   |
| t <sub>PHL</sub>                       |                                                                              | 2.0<br>4.5<br>6.0    | 220<br>44<br>37  | 275<br>55<br>47 | 330<br>66<br>56 |      |
| t <sub>PHL</sub>                       |                                                                              | 2.0<br>4.5<br>6.0    | 220<br>44<br>37  | 275<br>55<br>47 | 330<br>66<br>56 |      |
| t <sub>TLH</sub> ,<br>t <sub>THL</sub> | Maximum Output Transition Time, Any Output<br>(Figures 1 and 7)              | 2.0<br>4.5<br>6.0    | 75<br>15<br>13   | 95<br>19<br>16  | 110<br>22<br>19 | ns   |
| C <sub>in</sub>                        | Maximum Input Capacitance                                                    | —                    | 10               | 10              | 10              | pF   |

\* Applies to noncascaded/nonsynchronously clocked configurations only. With synchronously cascaded counters, (1) Clock to Ripple Carry Out propagation delays, (2) Enable T or Enable P to Clock setup times, and (3) Clock to Enable T or Enable P hold times determine f<sub>max</sub>. However, if Ripple Carry Out of each stage is tied to the Clock of the next stage (nonsynchronously clocked), the f<sub>max</sub> in the table above is applicable. See Applications Information in this data sheet.

**NOTES:**

1. For propagation delays with loads other than 50 pF, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).
2. Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

| C <sub>PD</sub> | Power Dissipation Capacitance (Per Package)* | Typical @ 25°C, V <sub>CC</sub> = 5.0 V |    |
|-----------------|----------------------------------------------|-----------------------------------------|----|
|                 |                                              | 60                                      |    |
|                 |                                              |                                         | pF |

\* Used to determine the no-load dynamic power consumption:  $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$ . For load considerations, see Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

# MC54/74HC160 MC54/74HC162

## TIMING REQUIREMENTS (Input $t_r = t_f = 6$ ns)

| Symbol     | Parameter                                                                 | V <sub>CC</sub><br>V | Guaranteed Limit |        |         | Unit |
|------------|---------------------------------------------------------------------------|----------------------|------------------|--------|---------|------|
|            |                                                                           |                      | - 55 to<br>25°C  | ≤ 85°C | ≤ 125°C |      |
| $t_{su}$   | Minimum Setup Time, Preset Data Inputs to Clock<br>(Figure 5)             | 2.0                  | 150              | 190    | 225     | ns   |
|            |                                                                           | 4.5                  | 30               | 38     | 45      |      |
|            |                                                                           | 6.0                  | 26               | 33     | 38      |      |
| $t_{su}$   | Minimum Setup Time, Load to Clock<br>(Figure 5)                           | 2.0                  | 135              | 170    | 205     | ns   |
|            |                                                                           | 4.5                  | 27               | 34     | 41      |      |
|            |                                                                           | 6.0                  | 23               | 29     | 35      |      |
| $t_{su}$   | Minimum Setup Time, Reset to Clock (HC162 only)<br>(Figure 4)             | 2.0                  | 160              | 200    | 240     | ns   |
|            |                                                                           | 4.5                  | 32               | 40     | 48      |      |
|            |                                                                           | 6.0                  | 27               | 34     | 41      |      |
| $t_{su}$   | Minimum Setup Time, Enable T or Enable P to Clock<br>(Figure 6)           | 2.0                  | 200              | 250    | 300     | ns   |
|            |                                                                           | 4.5                  | 40               | 50     | 60      |      |
|            |                                                                           | 6.0                  | 34               | 43     | 51      |      |
| $t_h$      | Minimum Hold Time, Clock to Preset Data Inputs<br>(Figure 5)              | 2.0                  | 50               | 65     | 75      | ns   |
|            |                                                                           | 4.5                  | 10               | 13     | 15      |      |
|            |                                                                           | 6.0                  | 9                | 11     | 13      |      |
| $t_h$      | Minimum Hold Time, Clock to Load<br>(Figure 5)                            | 2.0                  | 3                | 3      | 3       | ns   |
|            |                                                                           | 4.5                  | 3                | 3      | 3       |      |
|            |                                                                           | 6.0                  | 3                | 3      | 3       |      |
| $t_h$      | Minimum Hold Time, Clock to Reset (HC162 only)<br>(Figure 4)              | 2.0                  | 3                | 3      | 3       | ns   |
|            |                                                                           | 4.5                  | 3                | 3      | 3       |      |
|            |                                                                           | 6.0                  | 3                | 3      | 3       |      |
| $t_h$      | Minimum Hold Time, Clock to Enable T or Enable P<br>(Figure 6)            | 2.0                  | 3                | 3      | 3       | ns   |
|            |                                                                           | 4.5                  | 3                | 3      | 3       |      |
|            |                                                                           | 6.0                  | 3                | 3      | 3       |      |
| $t_{rec}$  | Minimum Recovery Time, Reset Inactive to Clock (HC160 only)<br>(Figure 2) | 2.0                  | 125              | 155    | 190     | ns   |
|            |                                                                           | 4.5                  | 25               | 31     | 38      |      |
|            |                                                                           | 6.0                  | 21               | 26     | 32      |      |
| $t_{rec}$  | Minimum Recovery Time, Load Inactive to Clock<br>(Figure 5)               | 2.0                  | 125              | 155    | 190     | ns   |
|            |                                                                           | 4.5                  | 25               | 31     | 38      |      |
|            |                                                                           | 6.0                  | 21               | 26     | 32      |      |
| $t_w$      | Minimum Pulse Width, Clock<br>(Figure 1)                                  | 2.0                  | 80               | 100    | 120     | ns   |
|            |                                                                           | 4.5                  | 16               | 20     | 24      |      |
|            |                                                                           | 6.0                  | 14               | 17     | 20      |      |
| $t_w$      | Minimum Pulse Width, Reset (HC160 only)<br>(Figure 2)                     | 2.0                  | 80               | 100    | 120     | ns   |
|            |                                                                           | 4.5                  | 16               | 20     | 24      |      |
|            |                                                                           | 6.0                  | 14               | 17     | 20      |      |
| $t_r, t_f$ | Maximum Input Rise and Fall Times<br>(Figure 1)                           | 2.0                  | 1000             | 1000   | 1000    | ns   |
|            |                                                                           | 4.5                  | 500              | 500    | 500     |      |
|            |                                                                           | 6.0                  | 400              | 400    | 400     |      |

NOTE: Information on typical parametric values can be found in Chapter 2 of the Motorola High-Speed CMOS Data Book (DL129/D).

## FUNCTION DESCRIPTION

The HC160/162 are programmable 4-bit synchronous counters that feature parallel Load, synchronous or asynchronous Reset, a Carry Output for cascading, and count-enable controls.

The HC160 and HC162 are BCD counters with asynchronous Reset, and synchronous Reset, respectively.

### INPUTS

#### Clock (Pin 2)

The internal flip-flops toggle and the output count advances with the rising edge of the Clock input. In addition, control functions, such as resetting (HC162) and loading occur with the rising edge of the Clock input.

#### Preset Data Inputs P0, P1, P2, P3 (Pins 3, 4, 5, 6)

These are the data inputs for programmable counting. Data on these pins may be synchronously loaded into the internal flip-flops and appear at the counter outputs. P0 (pin 3) is the least-significant bit and P3 (pin 6) is the most-significant bit.

### OUTPUTS

#### Q0, Q1, Q2, Q3 (Pins 14, 13, 12, 11)

These are the counter outputs (BCD or binary). Q0 (pin 14) is the least-significant bit and Q3 (pin 11) is the most-significant bit.

#### Ripple Carry Out (Pin 15)

When the counter is in its maximum state (1001 for the BCD counters or 1111 for the binary counters), this output goes high, providing an external look-ahead carry pulse that may be used to enable successive cascaded counters. Ripple Carry Out remains high only during the maximum count state. The logic equation for this output is:

$$\text{Ripple Carry Out} = \text{Enable T} \bullet \text{Q0} \bullet \overline{\text{Q1}} \bullet \overline{\text{Q2}} \bullet \text{Q3}$$

for BCD counters HC160 and HC162

## CONTROL FUNCTIONS

### Resetting

A low level on the Reset pin (pin 1) resets the internal flip-flops and sets the outputs (Q0 through Q3) to a low level. The HC160 resets asynchronously and the HC162 resets with the rising edge of the Clock input (synchronous reset).

### Loading

With the rising edge of the Clock, a low level on Load (pin 9) loads the data from the Preset Data Input pins (P0, P1, P2, P3) into the internal flip-flops and onto the output pins, Q0 through Q3. The count function is disabled as long as Load is low.

Although the HC160 and HC162 are BCD counters, they may be programmed to any state. If they are loaded with a state disallowed in BCD code, they will return to their normal count sequence within two clock pulses (see the Output State Diagram).

### Count Enable/Disable

These devices have two count-enable control pins: Enable P (pin 7) and Enable T (pin 10). The devices count when these two pins and the Load pin are high. The logic equation is:

$$\text{Count Enable} = \text{Enable P} \bullet \text{Enable T} \bullet \text{Load}$$

The count is either enabled or disabled by the control inputs according to Table 1. In general, Enable P is a count-enable control; Enable T is both a count-enable and a Ripple-Carry Output control.

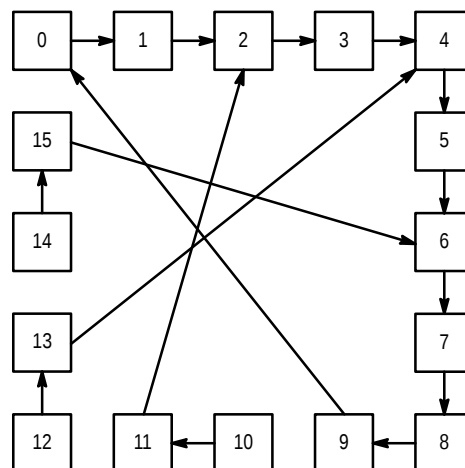
Table 1. Count Enable/Disable

| Control Inputs |          | Result at Outputs |          |                              |
|----------------|----------|-------------------|----------|------------------------------|
| Load           | Enable P | Enable T          | Q0 – Q3  | Ripple Carry Out             |
| H              | H        | H                 | Count    | High when Q0–Q3 are maximum* |
| L              | H        | H                 | No Count |                              |
| X              | L        | H                 | No Count | High when Q0–Q3 are maximum* |
| X              | X        | L                 | No Count | L                            |

\* Q0 through Q3 are maximum for the HC160 and HC162 when Q3 Q2 Q1 Q0 = 1001.

## OUTPUT STATE DIAGRAMS

### HC160 and HC162 BCD Counters



## SWITCHING WAVEFORMS

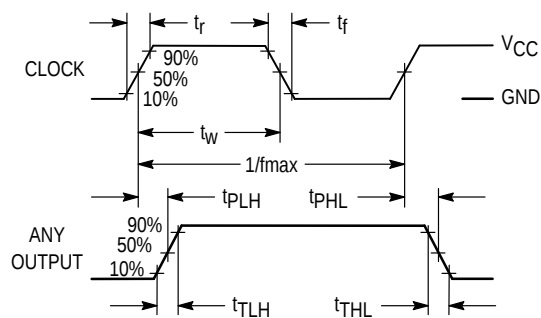


Figure 1.

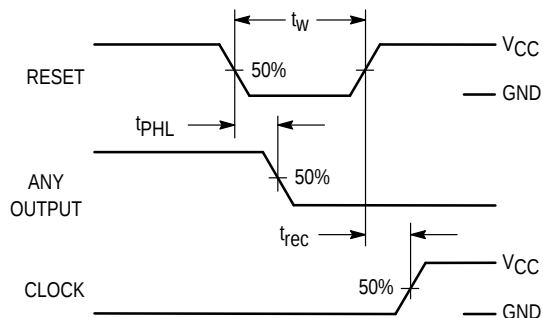


Figure 2.

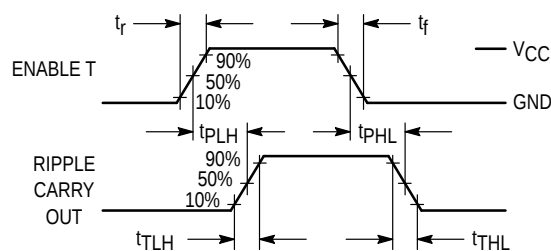


Figure 3.

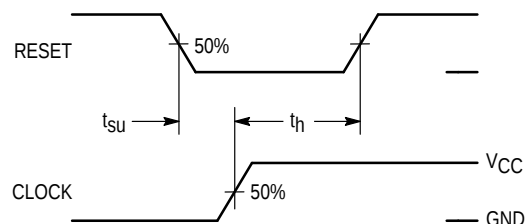


Figure 4. HC162 Only

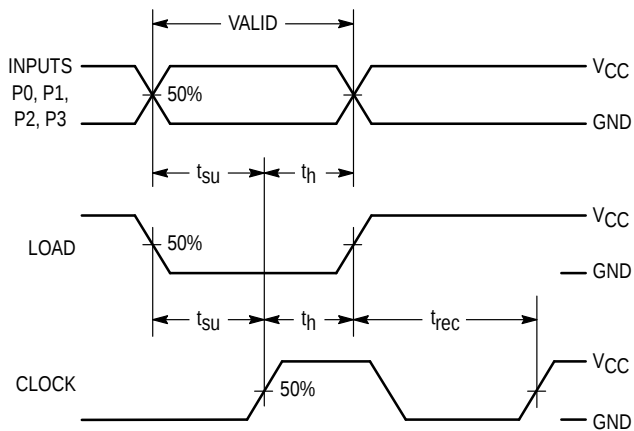


Figure 5.

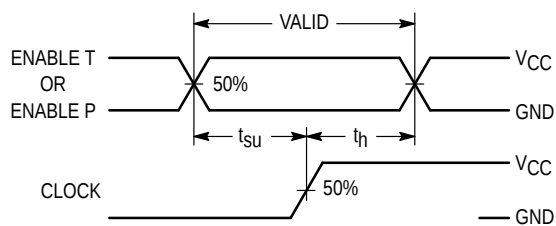
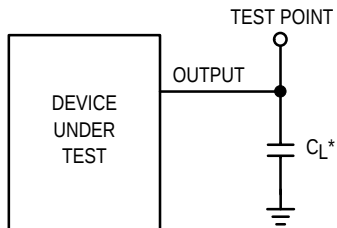


Figure 6.

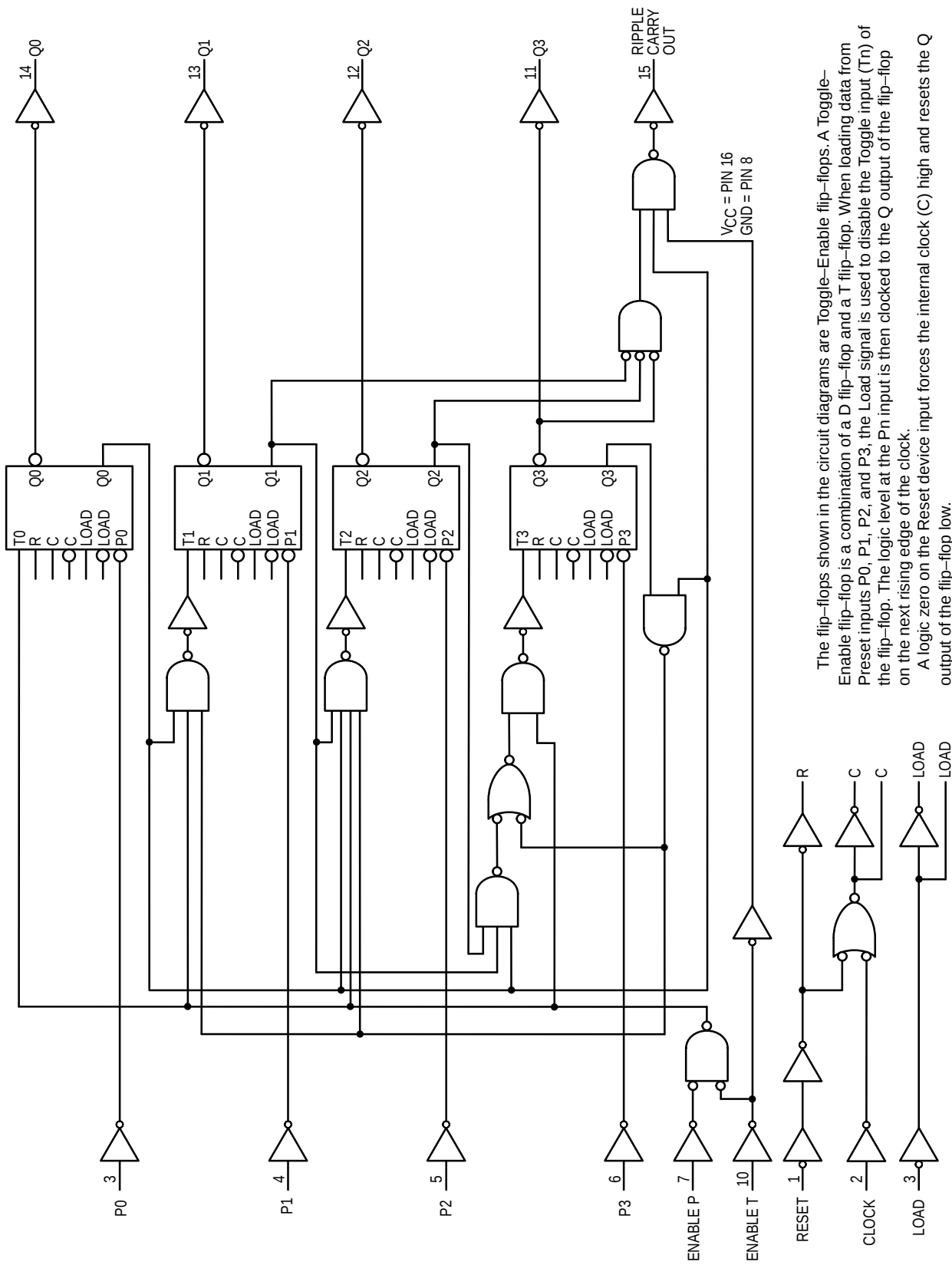
## TEST CIRCUIT



\* Includes all probe and jig capacitance

Figure 7.

MC54HC160 • MC74HC160  
BCD Counter with Asynchronous Reset

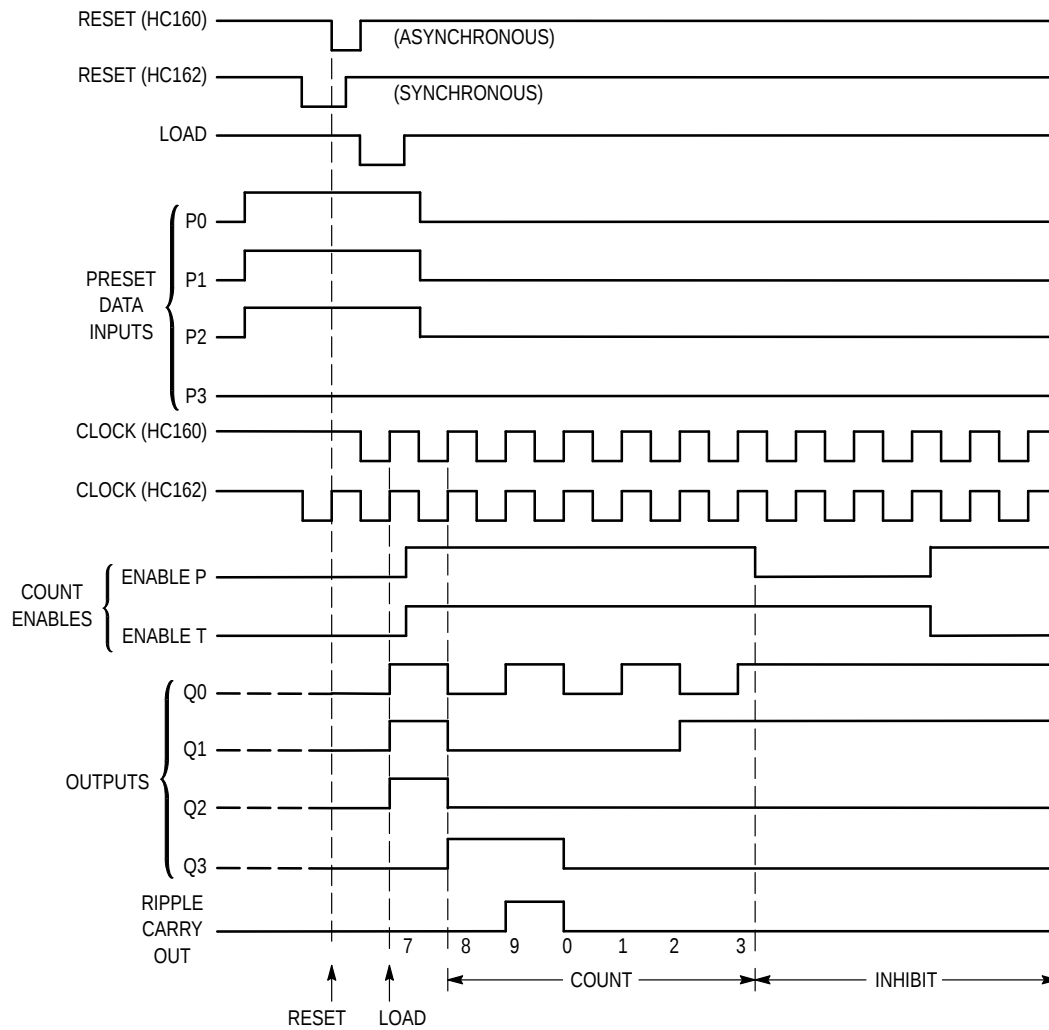


The flip-flops shown in the circuit diagrams are Toggle-Enable flip-flops. A Toggle-Enable flip-flop is a combination of a D flip-flop and a T flip-flop. When loading data from Preset inputs P0, P1, P2, and P3, the Load signal is used to disable the Toggle input (Tn) of the flip-flop. The logic level at the Pn input is then clocked to the Q output of the flip-flop on the next rising edge of the clock.  
A logic zero on the Reset device input forces the internal clock (C) high and resets the Q output of the flip-flop low.

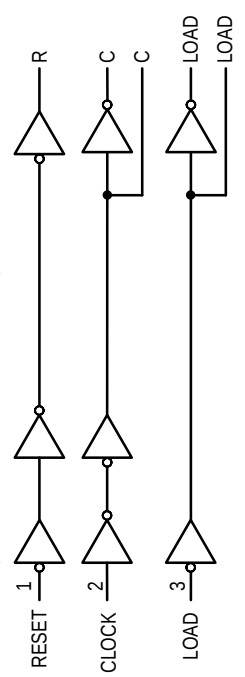
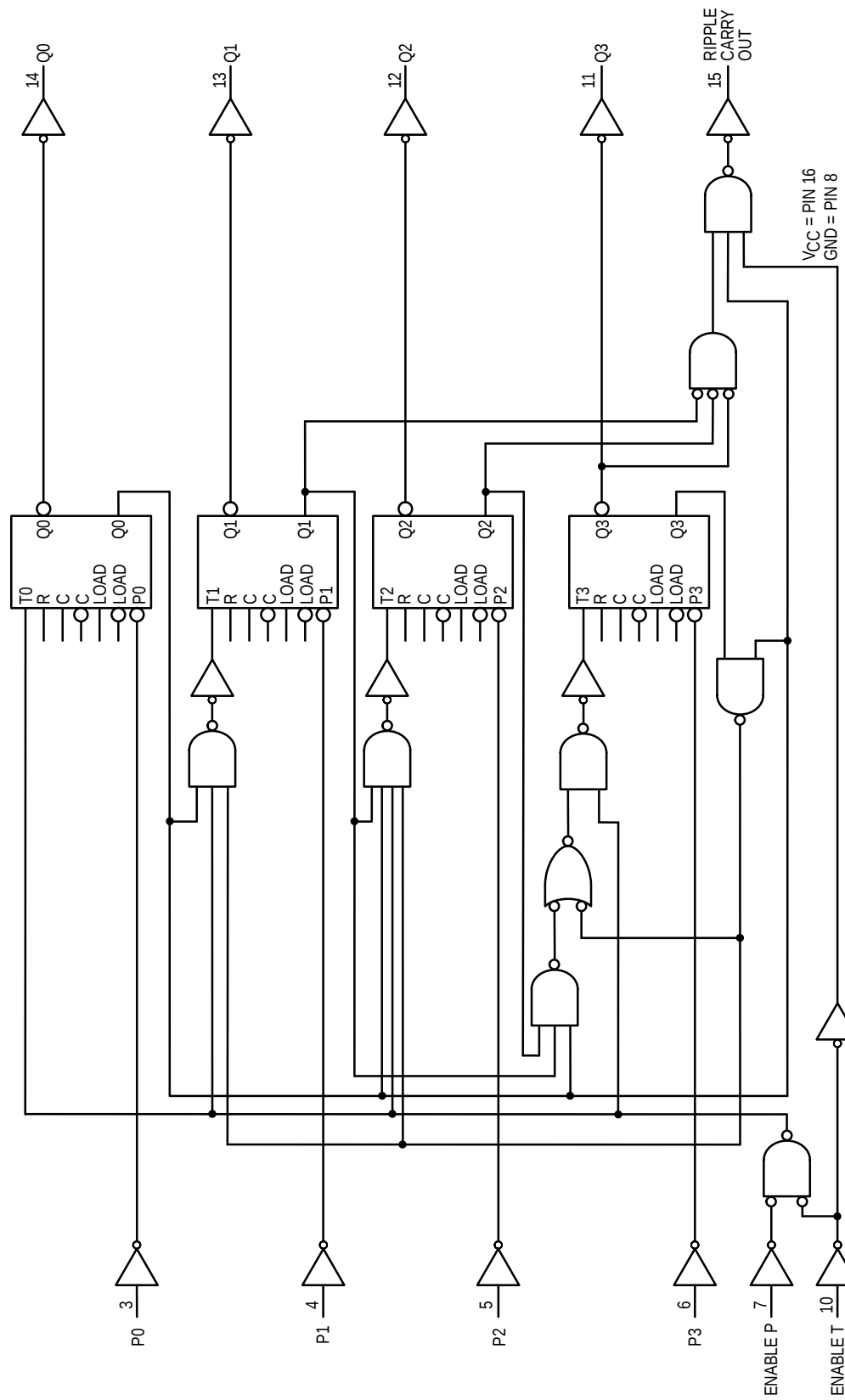
## HC160, HC162 TIMING DIAGRAM

Sequence illustrated in waveforms:

1. Reset outputs to zero.
2. Preset to BCD seven.
3. Count to eight, nine, zero, one, two, and three.
4. Inhibit.



MC54HC160 • MC74HC160  
BCD Counter with Synchronous Reset

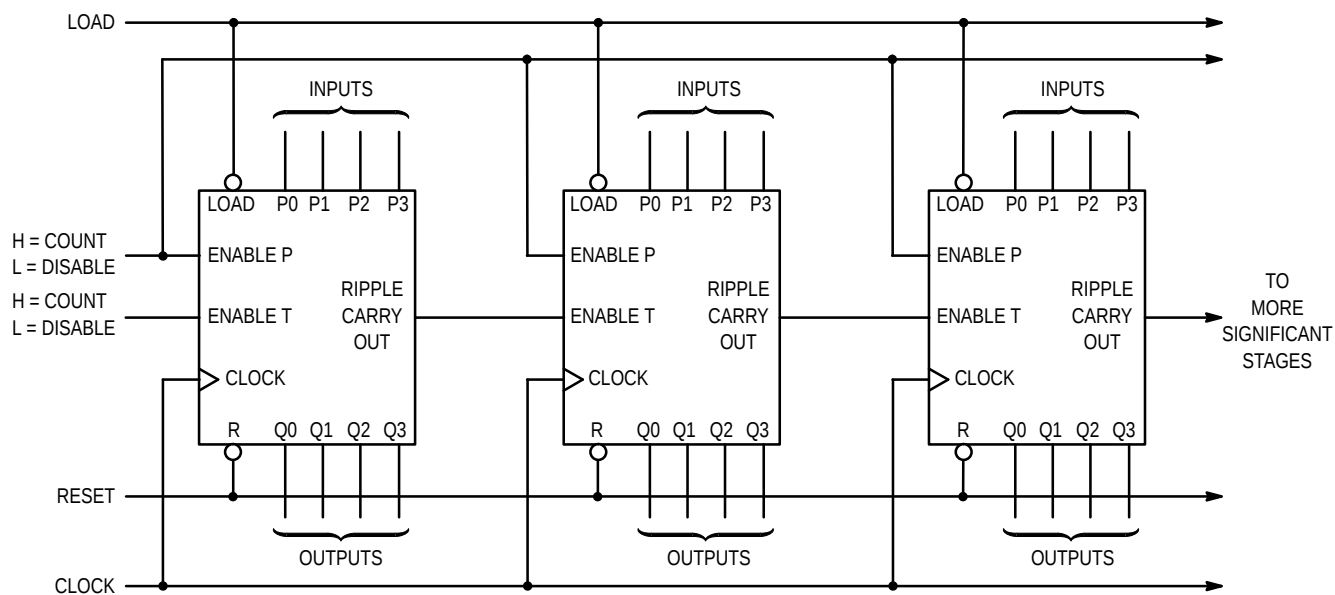


The flip-flops shown in the circuit diagrams are Toggle-Enable flip-flops. A Toggle-Enable flip-flop is a combination of a D flip-flop and a T flip-flop. When loading data from Preset inputs P0, P1, P2, and P3, the Load signal is used to disable the Toggle input (Tn) of the flip-flop. The logic level at the Pn input is then clocked to the Q output of the flip-flop on the next rising edge of the clock.

A logic zero on the Reset device input forces the internal clock (C) high and resets the Q output of the flip-flop low.

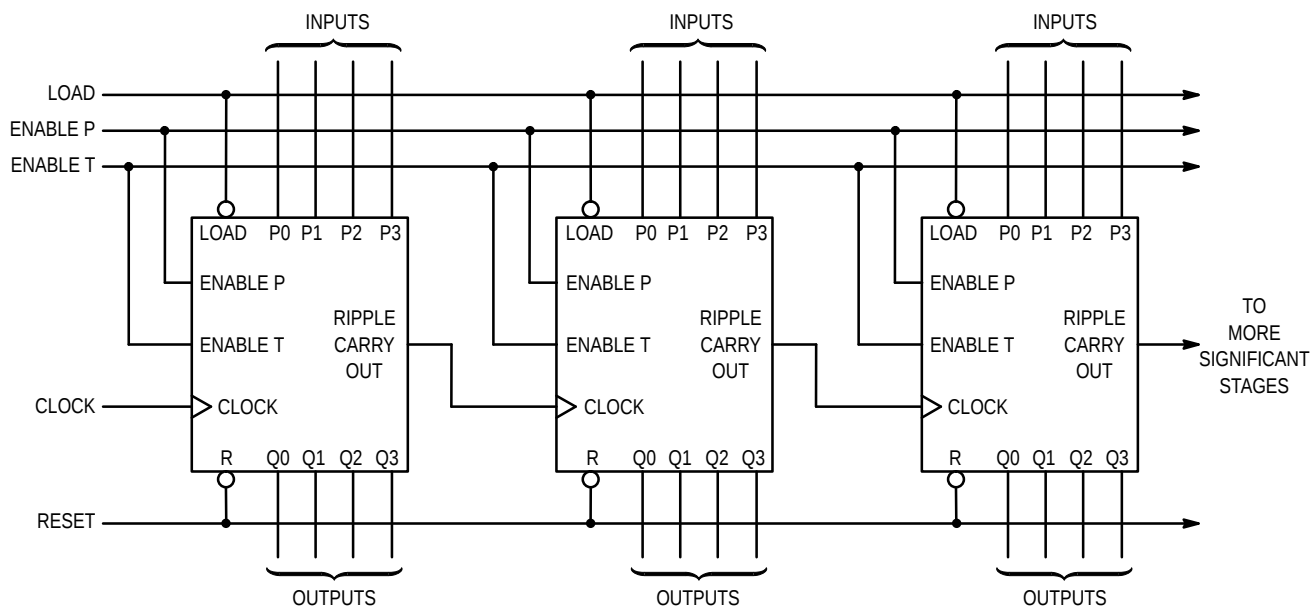
# TYPICAL APPLICATIONS CASCADING

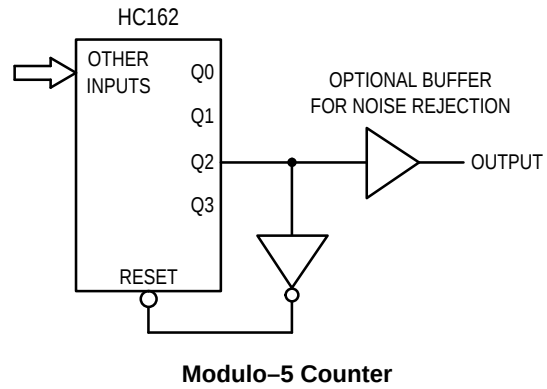
## N-Bit Synchronous Counters



NOTE: When used in these cascaded configurations the clock  $f_{max}$  guaranteed limits may not apply. Actual performance will depend on number of stages. This limitation is due to set up times between Enable (Port) and Clock.

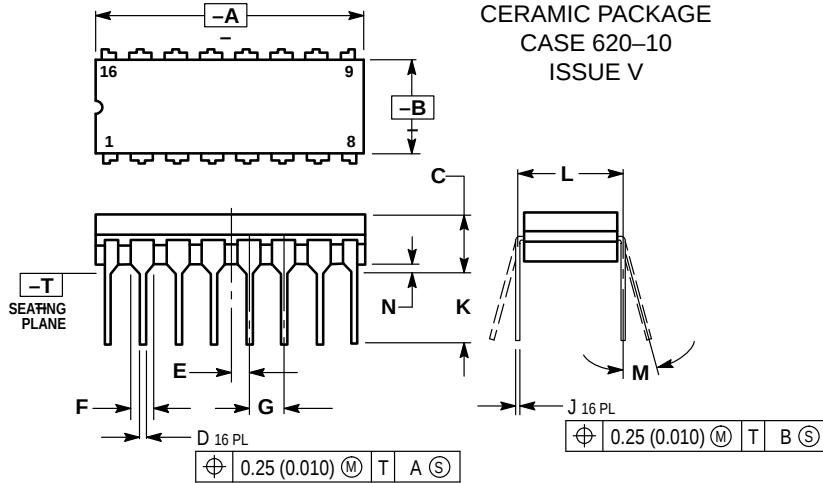
## Nibble Ripple Counter



**TYPICAL APPLICATION**

The HC162 facilitates designing counters of any modulus with minimal external logic. The output is glitch-free due to the synchronous Reset.

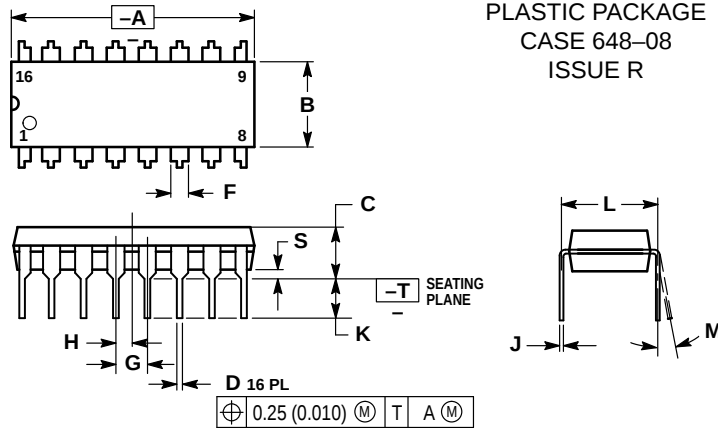
## OUTLINE DIMENSIONS

**J SUFFIX**  
 CERAMIC PACKAGE  
 CASE 620-10  
 ISSUE V


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
4. DIM F MAY NARROW TO 0.76 (0.030) WHERE THE LEAD ENTERS THE CERAMIC BODY.

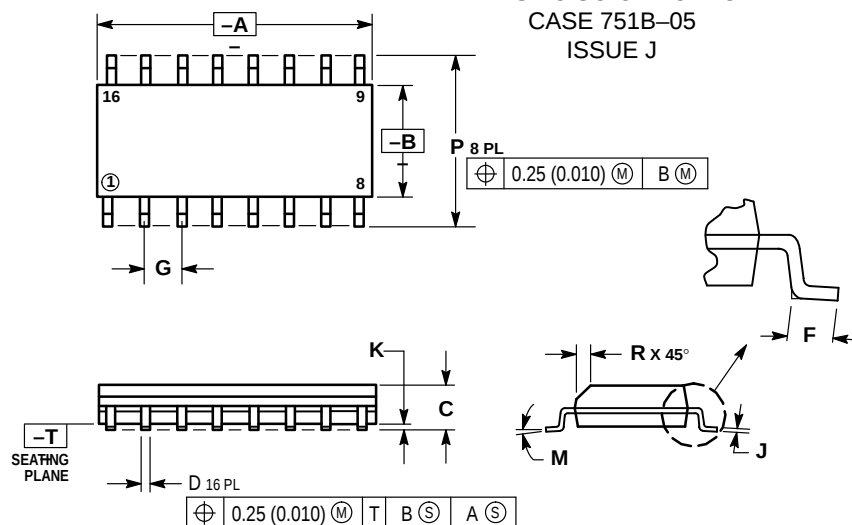
| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.750     | 0.785 | 19.05       | 19.93 |
| B   | 0.240     | 0.295 | 6.10        | 7.49  |
| C   | —         | 0.200 | —           | 5.08  |
| D   | 0.015     | 0.020 | 0.39        | 0.50  |
| E   | 0.050 BSC |       | 1.27 BSC    |       |
| F   | 0.055     | 0.065 | 1.40        | 1.65  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| J   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.125     | 0.170 | 3.18        | 4.31  |
| L   | 0.300 BSC |       | 7.62 BSC    |       |
| M   | 0°        | 15°   | 0°          | 15°   |
| N   | 0.020     | 0.040 | 0.51        | 1.01  |

**N SUFFIX**  
 PLASTIC PACKAGE  
 CASE 648-08  
 ISSUE R


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: INCH.
3. DIMENSION L TO CENTER OF LEADS WHEN FORMED PARALLEL.
4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.
5. ROUNDED CORNERS OPTIONAL.

| DIM | INCHES    |       | MILLIMETERS |       |
|-----|-----------|-------|-------------|-------|
|     | MIN       | MAX   | MIN         | MAX   |
| A   | 0.740     | 0.770 | 18.80       | 19.55 |
| B   | 0.250     | 0.270 | 6.35        | 6.85  |
| C   | 0.145     | 0.175 | 3.69        | 4.44  |
| D   | 0.015     | 0.021 | 0.39        | 0.53  |
| F   | 0.040     | 0.070 | 1.02        | 1.77  |
| G   | 0.100 BSC |       | 2.54 BSC    |       |
| H   | 0.050 BSC |       | 1.27 BSC    |       |
| J   | 0.008     | 0.015 | 0.21        | 0.38  |
| K   | 0.110     | 0.130 | 2.80        | 3.30  |
| L   | 0.295     | 0.305 | 7.50        | 7.74  |
| M   | 0°        | 10°   | 0°          | 10°   |
| S   | 0.020     | 0.040 | 0.51        | 1.01  |

**D SUFFIX**  
 PLASTIC SOIC PACKAGE  
 CASE 751B-05  
 ISSUE J


## NOTES:

1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
2. CONTROLLING DIMENSION: MILLIMETER.
3. DIMENSIONS A AND B DO NOT INCLUDE MOLD PROTRUSION.
4. MAXIMUM MOLD PROTRUSION 0.15 (0.006) PER SIDE.
5. DIMENSION D DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE DAMBAR PROTRUSION SHALL BE 0.127 (0.005) TOTAL IN EXCESS OF THE D DIMENSION AT MAXIMUM MATERIAL CONDITION.

| DIM | MILLIMETERS |       | INCHES    |       |
|-----|-------------|-------|-----------|-------|
|     | MIN         | MAX   | MIN       | MAX   |
| A   | 9.80        | 10.00 | 0.386     | 0.393 |
| B   | 3.80        | 4.00  | 0.150     | 0.157 |
| C   | 1.35        | 1.75  | 0.054     | 0.068 |
| D   | 0.35        | 0.49  | 0.014     | 0.019 |
| F   | 0.40        | 1.25  | 0.016     | 0.049 |
| G   | 1.27 BSC    |       | 0.050 BSC |       |
| J   | 0.19        | 0.25  | 0.008     | 0.009 |
| K   | 0.10        | 0.25  | 0.004     | 0.009 |
| M   | 0°          | 7°    | 0°        | 7°    |
| P   | 5.80        | 6.20  | 0.229     | 0.244 |
| R   | 0.25        | 0.50  | 0.010     | 0.019 |

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